

09-27-2006



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IN THE UNITED STATES

Atty Docket No: 0553-0531

MARK OFFICE

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Date of Deposit September 21, 2006

In re application of: Kengo AKIMOTO et al.  
 Serial No: )  
 Filed: Herewith )  
 For: Semiconductor Device And Manufacturing Method Thereof )  
 Art Unit: )  
 Examiner: )

I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above, and is addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450

## PATENT ASSIGNMENT COVER SHEET

Commissioner for Patents  
 P. O. Box 1450  
 Alexandria, VA 22313-1450

Name: ARMANDO CHING  
 (typed or printed)

Signature Armando Ching

Sir:

Please record the attached original document or copy thereof. Total number of pages (with cover sheet): 2

<p>1. Name of Conveying Party(ies):  <u>Kengo AKIMOTO, Tatsuya HONDA and Norihito SONE</u></p> <p>2a. Name and Address of Receiving Party(ies):          Name: <u>Semiconductor Energy Laboratory Co., Ltd.</u>          Address: <u>398, Hase, Atsugi-shi, Kanagawa-ken</u>  <u>243-0036 Japan</u></p> <p>2b. Name and Address of Receiving Party(ies):          Name: _____          Address: _____</p> <p>3. Nature of Conveyance  <input checked="" type="checkbox"/> Assignment  <input type="checkbox"/> Merger  <input type="checkbox"/> Security Agreement  <input type="checkbox"/> Change of Name  <input type="checkbox"/> Other _____  <input checked="" type="checkbox"/> Execution Date: <u>9/5/06; 9/5/06; 9/6/06</u></p> <p>4. Application Number(s) or Patent number(s) (If this document is being filed together with a new application, the execution date of the application is: <u>9/5/06; 9/5/06; 9/6/06</u>)</p> <p>4a. Patent Application No.(s) _____</p> <p>4b. Patent No.(s) _____</p>	<p>5. Name and Address of Party to Whom Correspondence Concerning Document Should be Mailed:  <u>Edward D. Manzo, Esq.</u>  <u>COOK, ALEX, McFARRON, MANZO, CUMMINGS &amp; MEHLER, LTD.</u>  <u>200 West Adams Street, Suite 2850</u>  <u>Chicago, Illinois 60606</u></p> <p>6. Total Number of Applications and Patents Involved: <u>1</u></p> <p>7. Total Fee (37 CFR 3.41): <u>\$40.00</u>          7a. <input checked="" type="checkbox"/> Enclosed          7b. <input checked="" type="checkbox"/> Authorized to be Charged to Deposit Account For Any Deficiency</p> <p>8. Deposit Account Number: <u>50/1039</u>          (A duplicate copy of this page is attached)</p> <p>9. Statement and Signature:  <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i></p> <p><u>Mark J. Murphy</u>          Name of Person Signing      Signature          Reg. No. 34,225          Date: September <u>21</u>, 2006</p>
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PATENT  
 REEL: 018331 FRAME: 0408

# ASSIGNMENT

**Identity Of The Patent Application.** I am the inventor (or one joint inventor) of a patent application that I am assigning. The patent application I am assigning is entitled SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF which I executed herewith. If the patent application has already been filed, it received serial number \_\_\_\_\_ and bears a filing date of \_\_\_\_\_.

**The Assignee and The Assignment.** I assign my patent rights to Semiconductor Energy Laboratory Co., Ltd. a corporation organized according to the laws of Japan, having a place of business at 398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan (hereinafter "the Assignee"). The rights I assign are my entire right, title and interest in the invention or improvements disclosed in the patent application and any and all other applications for United States Letters Patent which I may file, either solely or jointly with others, on the invention or improvements, including all continuations, divisionals, and continuations-in-part, and in any and all United States Letters Patent which may be obtained on any of said applications, and in any reissue or extension thereof. I also assign to the Assignee all priority rights under the International Convention. I agree to execute, at the request of the Assignee, all documents in connection with any application for United States letters patent therefor.

**Payment Received.** I am making this assignment in consideration of One Dollar and other good and valuable consideration. I acknowledge the receipt and sufficiency of the consideration.

**Authorizations.** I request the U.S. Commissioner of Patents and Trademarks to issue the Letters Patent to the Assignee. I authorize the attorney(s) of record in the application to insert in this assignment document the date and serial number of the application.

**Further Acts.** I agree, upon the request and at the expense of the Assignee, to execute any divisional, continuation or substitute application for the invention or improvements, and any oath, declaration or affidavit relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon the application. I agree to perform, upon request, any affirmative acts to obtain said Letters Patent of the United States and to vest in the Assignee all rights therein, so that the Letters Patent will be held and enjoyed by the Assignee, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me if this assignment had not been made.

**Interference.** In the event that any application or Letters Patent that I now assign becomes involved in interference, I agree to cooperate to the best of my ability in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof.

Kengo AKIMOTO  
Name: Kengo AKIMOTO

09/05/2006  
Date

Tatsuya HONDA  
Name: Tatsuya HONDA

09/05/2006  
Date

Norihito SONE  
Name: Norihito SONE

09/06/2006  
Date

PATENT

RECORDED: 09/21/2006

REEL: 018331 FRAME: 0409